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SPEC No. LCY-11014B FILE No. ISSUE: May. 24. 2011 PAGE: 29 pages

APPROVED BY: DATE

> DISPLAY DEVICE BUSINESS GROUP SHARP CORPORATION

## **SPECIFICATION**

## DEVICE SPECIFICATION FOR

TFT - LCD module

MODEL No. LQ101K5DZ01

CUSTOMER'S APPROVAL	
DATE	
	PRESENTED
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DEPARTMENT GENERAL MANAGER DEVELOPMENT DEPT. II LIQUID CRYSTAL DISPLAY DIVISION II DISPLAY DEVICE GROUP SHARP CORPORATION

# RECORDS OF REVISION

MODEL NO. LQ101K5DZ01

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SPEC No.	Date	NO.	PAGE	SUMMARY	NOTE
LCY-11014A	Apr.20. 2011	-	-	1 <sup>st</sup> Release	
LCY-11014B	May.24.2011	-	P.6	THM_LCD and THM_BL value is changed	
				THM_LCD: $1400 \Omega$ → $1250 \Omega$	
				THM_BL : 900 Ω →830 Ω	
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#### 1. General

This TFT-LCD module is a color active matrix LCD (Liquid Crystal Display) module of transmissive type incorporating amorphous silicon TFT (<u>Thin Film Transistor</u>).

General specification of the module is shown in the Table 3-1.

It is composed of a color TFT-LCD panel, driver ICs, PWB, FPC(between color TFT-LCD panel and control PWB), shielding back case, front case, backlight unit.

## 2. Features

- •Utilizes a panel with a 27.3:9 aspect ratio, which makes the module suitable for use in wide-screen systems.
- •The 10.1 inch screen produces a high resolution image that is composed of 540160 pixels in a vertical stripe arrangement.
- •Graphics and texts can be displayed on a 1280×RGB×422 dots panel with 16,194,277 colors by supplying 24 bits (8 bits×RGB) data signal. FRC technology is used for this LCD module.
- •Wide viewing field angle technology is employed.
- •By adopting an active matrix drive, a picture with high contrast is realized.
- •Reduced reflection as a result of low reflection black matrix and an antiglare (AG) and antireflection (AR) polarizer being adopted. The polarizer reflectance is 1.5% Typical.
- •By COG method, realized a slim, lightweight, and compact module.
- •Realizes a high quality natural color appearance by adopting "Normally Black LC Mode".
- •The backlight achieves fast turn on characteristics across the complete automotive temperature range.

## 3. Mechanical specifications (Dot Composition)

General Specification of the Module Table 3-1

Parameter	Specifications	Units	Remarks
Display format	540,160	pixels	
	1280(RGB)W×422H	dots	
Active area	242.88(W)×80.07(H)	mm	
Screen size (Diagonal)	25.7 [ 10.1 " ]	cm	
Dot pitch	0.063(W)×0.189(H)	mm	
Pixel configuration	R,G,B Stripe configuration		
Outline dimension	259.7 (W)×96.5 (H)×15.0(D)	mm	[Note 3-1]
Mass	470	g	

## [Note 3-1]

Excluding protrusions. Typical values are given.

For detailed measurements and tolerances, please refer to Fig. 1.

**4. Input terminal and its function**4-1 TFT-LCD panel driving part: Connector used: FH41-68S-0.5SH(05) (HRS)

Table 4-1

Pin No.	Symbol	Description	Remarks
1	GND	GND for circuit	
2	N.C.	OPEN	
3	VCC	Logical Power Supply (+3.3V power supply)	
4	VCC	Logical Power Supply (+3.3V power supply)	
5	N.C.	OPEN	
6	GND	GND for circuit	
7	THM_LCD	Thermistor to sense module temperature	[Note4-3]
8	LCD ERROR	LCD Error signal	[Note4-5]
9	PON	Display reset signal	
10	VRV	Turning the direction of vertical scanning	[Note4-4]
11	HRV	Turning the direction of horizontal scanning	[Note4-4]
12	GND	GND for circuit	
13	VD	Vertical sync	[Note4-1]
14	HD	Horizontal sync	[Note4-1]
15	DEN	Horizontal Data Enable	[Note4-2]
16	GND	GND for circuit	
17	NCLK	Clock signal for sampling each data signal	
18	GND	GND for circuit	
19	R0	RED data signal (LSB)	
20	R1	RED data signal	
21	GND	GND for circuit	
22	R2	RED data signal	
23	R3	RED data signal	
24	GND	GND for circuit	
25	R4	RED data signal	
26	R5	RED data signal	
27	GND	GND for circuit	
28	R6	RED data signal	
29	R7	RED data signal(MSB)	
30	GND	GND for circuit	
31	G0	GREEN data signal (LSB)	
32	G1	GREEN data signal	
33	GND	GND for circuit	
34	G2	GREEN data signal	
35	G3	GREEN data signal	
36	GND	GND for circuit	
37	G4	GREEN data signal	
38	G5	GREEN data signal	

			101 110
39	GND	GND for circuit	
40	G6	GREEN data signal	
41	G7	GREEN data signal(MSB)	
42	GND	GND for circuit	
43	В0	BLUE data signal (LSB)	
44	B1	BLUE data signal	
45	GND	GND for circuit	
46	B2	BLUE data signal	
47	В3	BLUE data signal	
48	GND	GND for circuit	
49	B4	BLUE data signal	
50	B5	BLUE data signal	
51	GND	GND for circuit	
52	В6	BLUE data signal	
53	В7	BLUE data signal(MSB)	
54	GND	GND for circuit	
55	BL_ERROR	Backlight Error signal	[Note4-5]
56	BL_PWM	PWM control for LED driver	
57	N.C.	OPEN	
58	B+	POWER for LED circuit	
59	B+	POWER for LED circuit	
60	B+	POWER for LED circuit	
61	B+	POWER for LED circuit	
62	B+	POWER for LED circuit	
63	N.C.	OPEN	
64	GND	GND for circuit	
65	GND	GND for circuit	
66	GND	GND for circuit	
67	THM_BL	Thermistor to sense backlight temperature	[Note4-3]
68	GND	GND for circuit	

## [Note4-1]

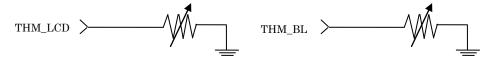
Hsync	Negative polarity
Vsync	Negative polarity

[Note4-2] The horizontal display starting position is settled in accordance with a rising timing of DEN signal. (Refer to Fig.2)

In case DEN is fixed to "Low", the horizontal display starting position is determined as described in Fig.2.(Don't keep DataEn "High" during operation.)

[Note4-3] THM\_LCD parts number: NSM2103F344F3 (OHIZUMI) THM BL parts number: NSS4103F39F (OHIZUMI)

THM LCD and THM BL connections are shown below:



## [Note4-4]

HRV="Lo": Regular video

HRV="Hi": Horizontally inverted video

The HRV signal is pulled up to 3.3V through a  $100 \mathrm{K}\Omega$  resistor within ASIC and pulled down to GND through a  $10 \mathrm{K}\Omega$  on the PCB board.

VRV="Lo": Regular video

VRV="Hi": Vertically inverted video

The VRV signal is pulled up to 3.3V through a  $100 \mathrm{K}\Omega$  resistor within ASIC and pulled down to GND through a  $10 \mathrm{K}\Omega$  on the PCB board.

When they are used with OPEN, the display shows regular video.

## [Note4-5]

LCD error signal is active "Lo" BL error signal is active "Lo"

LCD error pin and BL error pin are set as Open-drain.

If these pins are pulled up, please insert the pull-up resister  $(10K\Omega)$  in these line.

Refer to Appendix A for functional description of LCD\_Error and BL\_Error pins.

## 5. Absolute maximum ratings

Table 5-1 GND=0V

14310 3 1				GITE OF				
Parameter	Symbol	MIN	MAX	Unit	Note			
Input voltage for back light	VB+	-0.3	21.0V	V				
+3.3V power supply	Vcc	-0.3	+4.6	V				
Input signal voltage 1	Vi1	-0.3	Vcc+0.3	V	[Note5-1]			
Input signal voltage 2	Vi2	-0.3	"VB+" +0.3	V	[Note5-2]			
Storage temperature	Tstg	-40	95	°C	[Note5-3,4]			
Operating temperature (LCD panel surface)	Topr1	-30	85	°C	[Note5-3,4,5,6]			
Operating temperature ( Ambient temperature )	Topr2	-40	85	°C	[Note5-6]			

- [Note5-1] HD, DEN, VD, NCLK, B0~B7, G0~G7, R0~R7, PON, HRV, VRV
- [Note5-2] BL\_PWM
- [Note5-3] This rating applies to all parts of the module and should not be exceeded.

  The specified temperature provides the maximum value within 5mm around the module.
- [Note5-4] Maximum wet-bulb temperature is to be less than 58°C. Condensation of dew must be avoided as electrical current leaks will occur, causing a degradation of performance specifications.
- [Note5-5] The operating temperature only guarantees operation of the circuit. Specifications (contrast ratio, response time and other factors related to display quality) are determining at ambient temperature (Ta=25°C).
- [Note5-6] Ambient temperature when the backlight is lit. (by PWM).

  PWM dimming shall operate at Ta≥+75°C. (it applies to LCD module only)

  (See attached below figure)

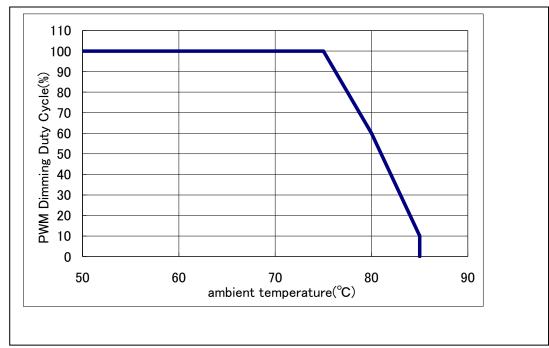
Do not allow THM LCD value to fall below  $1250 \Omega$ 

Do not allow THM\_BL value to fall below  $830 \Omega$ 

The display reduce performance level between  $-40^{\circ}$ C  $\leq$  Ta  $\leq$   $-30^{\circ}$ C and

 $+75^{\circ}$ C  $\leq$  Ta  $\leq$   $+85^{\circ}$ C

Countermeasures for heat generation from LCD module such as heat sink are mandatory at customer's system.



[Note5-7] The above graph is reference data as LCD alone.

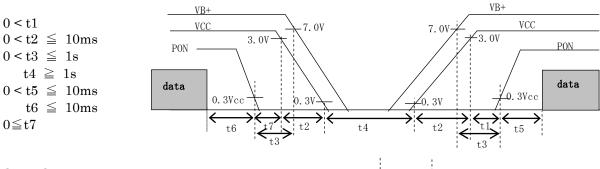
## 6. Electrical characteristics

## 6-1 TFT-LCD panel driving section

Table 6-1	001011				Ta= 25°C					
Parameter	Symbol	MIN	TYP	MAX	Unit	Remarks				
Backlight										
Supply voltage	VB+	7.0	13.5	18.0	V	[Note6-1][Note6-4]				
Current dissipation	IB+	_	370	750	mA	Max:VB+=7V				
Input Low voltage	$V_{\rm IL\_PWM}$	GND	_	0.4	V	BL_PWM terminal				
Input High voltage	V <sub>IH_PWM</sub>	2.1	_	5.5	V					
Input current (Low)	$I_{IL\_PWM}$	_	_	2.0	$\mu$ A	$V_{IB}$ =0V or 5.5V				
Input current (High)	I <sub>IH_PWM</sub>	—		2.0	$\mu$ A	"BL_PWM" terminal				
Output low voltage	Vol_ble	GND	_	0.4	V	BL_Error terminal				
Leakage current	I <sub>IL_BLE</sub>		_	1.0	μΑ	"BL_Error"=5.5V				
LCD Logic										
Supply voltage	Vcc	+3.0	+3.3	+3.6	V	[Note6-1]				
Current dissipation	Icc	_	400	500	mA	[Note6-2]				
Permissive input ripple	$V_{\mathrm{RF}}$	_	_	100	mVpp					
Input Low voltage	$V_{\rm IL1}$	GND		0.8	V	[Note6-3]				
Input High voltage	$V_{\mathrm{IH1}}$	2.0	_	VCC	V					
Negative trigger voltage	$V_{NT}$	0.6	_	1.8	V	PON terminal				
Positive trigger voltage	$V_{\mathrm{PT}}$	1.2	_	2.4	V					
Hysteresis voltage	V <sub>HYS</sub>	0.5	_	1.0	V					
Input current 1 (Low)	$I_{\rm IL1}$	_	_	10.0	μΑ	V <sub>I</sub> =0V or V <sub>CC</sub>				
Input current 1 (High)	$ m I_{IH1}$	_	_	10.0	$\mu$ A	[Note 6-3]				
Input current 2 (Low)	$I_{\rm IL1}$	_	_	-64.0	$\mu$ A	V <sub>I</sub> =0V or V <sub>CC</sub>				
Input current 2 (High)	$ m I_{IH1}$	—	_	44.0	$\mu$ A	"HD,VD,DEN"terminal				
Input current 3(Low)	$I_{\rm IL3}$	_	_	-64.0	$\mu$ A	VI = 0V or Vcc				
Input current 3(High)	$ m I_{IH3}$	_	-	400	$\mu$ A	"HRV,VRV"terminal				
Output Low Voltage	Vol_lcde	GND	_	0.4	V	LCD_Error terminal				
leakage Current	I <sub>IL_LCDE</sub>		_	2.0	$\mu$ A	LCD_Error =5.5V				

## [Note6-1]

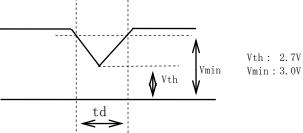
On-off conditions for supply voltage



## $\cdot$ Voltage drop

- 1)  $Vth \leq Vcc < Vmin$  $td \leq 10ms$
- 2) Vcc<Vth

Vcc-dip conditions should also follow the On-off conditions for supply voltage



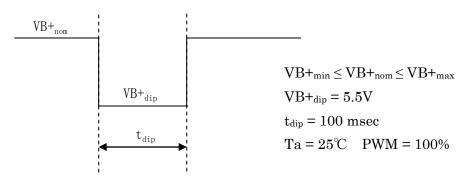
- Every signal is CMOS data, Hi-Z is prohibited when Vcc is high level.
- When PON signal turns off, display pattern may be un-controlled for an instance.

## [Note6-2]

Typical current situation: Gray scale 253 pattern
Timing: Typical VCC= +3.3V

## [Note 6-3] NCLK , B0 $\sim$ B7 , G0 $\sim$ G7 , R0 $\sim$ R7

## [Note 6-4]



VB+ can accept +5.5V for 100msec. IB+ is 1.5A, when +5.5V is applied to VB+. LCD backlight will not blink during VB+ dip condition.

## 7. Timing Characteristics of input signals

7-1) Timing characteristics

Table 7-1  $Ta = 25^{\circ}C$ 

Paran	neter	Symbol	Min.	Тур.	Max.	Unit	Note
Clock	Frequency	fCLK	43.78	44.24	44.69	MHz	
[NCLK]	Hi_Time	tWCH	5	_	_	ns	
	Lo_Time	tWCL	5	_	_	ns	
Data	Setup time	tDS	5	_	_	ns	
[I* 0-5]	Hold time	tDH	5	_	_	ns	
Horizontal sync.signal	Cycle	tH(t)	34.36	34.72	35.08	us	
[HD]		tH(clk)	1504	1536	1568	ck	
	Pulse width	tHPW	5	_	TH-5	ck	
Vertical sync.	Cycle	tV	475	480	485	line	
Signal [VD]	Pulse width	tVPW	2	_	TV-2	line	
Frame rate		fV		60		Hz	
Horizontal disp	lay period	tHA		1280		ck	only 1280ck
HD_NCLK phas	se difference	tHC	A-8	A	A+8	ns	A=Tc/2 (Tc=1/fCLK)
HD_VD phase of	lifference	tVH	-10	0	10	ck	
Vertical front po	orch	tVFP	8	_		line	
Vertical back po	orch	tVBP		35		line	only 35 line
Vertical display	period	tVA		422		line	only 422 line
Enable signal	Setup time	tES	5	_	_	ns	[Note 7-1]
[HENAB]	Hold time	the	5	_	_	ns	
	Pulse width	tEP		1280		ck	[Note 7-1] only 1280ck
Horizontal fron	t porch	tHFP	8	_	_	ck	
Horizontal back	Horizontal back porch			194		ck	[Note 7-2] only 194ck
			20	_	222	ck	[Note 7-3]
PWM Dimming	Frequency	fpwm	150	_	250	Hz	BL_PWM
PWM Dimming	Duty Cycle		1.0	_	100	%	

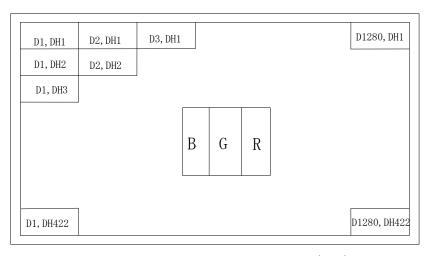
<sup>[</sup>Note 7-1] Enable signal must be input into Vertical invalid data period as well as Vertical display period.

<sup>[</sup>Note 7-2] This spec is applied for DEN Low fix mode.

<sup>[</sup>Note 7-3] This spec is applied for DEN active mode.

## 7-2) Input Data Signals and Display Position on the screen Refer to the following figure





Display position of input data (H,V)

## 8. Input Signals, Basic Display Color and Gray Scale of Each Color

Table 8-1

	ible 8-1												Data	sion	nal											
	Colors &	Gray											Dutt	. 5151												
	Gray scale	Scale	R0	R1	R2	R3	R4	R5	R6	R7	GO	G1	G2	G3	G4	G5	G6	G7	ВО	B1	B2	В3	B4	В5	В6	В7
	Black	_	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	_	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Х	X	1	1	1	1	1	1
l I	Green	_	0	0	0	0	0	0	0	0	X	X	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Basic	Cyan	_	0	0	0	0	0	0	0	0	Х	Х	1	1	1	1	1	1	Х	X	1	1	1	1	1	1
Basic Color	Red	_	Х	Х	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
lor	Magenta	_	Х	Х	1	1	1	1	1	1	0	0	0	0	0	0	0	0	X	Х	1	1	1	1	1	1
	Yellow	_	Х	Х	1	1	1	1	1	1	Х	Х	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	_	X	Х	1	1	1	1	1	1	Х	X	1	1	1	1	1	1	Х	X	1	1	1	1	1	1
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Û	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale of Red	仓	<b>\</b>					ν							_	l							,	V			
ıle o	Û	<b>\</b>					L				↓ ↓						$\downarrow$									
f Re	Brighter	GS250	0	1	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
р	Û	GS251	1	1	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	GS252	Х	X	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
G	Û	GS1	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale of Green	Darker	GS2	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	仓	<b>+</b>				1	l l							7	ı							,	V			
e of	Û	<b>→</b>					L							7	L							,	V			
Gree	Brighter	GS250	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1	1	0	0	0	0	0	0	0	0
ń	Û	GS251	0	0	0	0	0	0	0	0	1	1	0	1	1	1	1	1	0	0	0	0	0	0	0	0
	Green	GS252	0	0	0	0	0	0	0	0	X	X	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0	Û	GS1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
iray	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
Scal	Û	<b>\</b>					- <u>-</u>					_		7	  -		_			_			V			
e of	Û	<b>→</b>	↓ ↓				<b>\</b>										V									
Gray Scale of Blue	Brighter	GS250	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1	1
0	Û	GS251	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	1	1	1	1	1
	Blue	GS252	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	X	X	1	1	1	1	1	1

0: Low level 1:H

1:High level X: Don't care

Each basic color can be displayed in 253 gray scales by 8 bit data signals. According to the combination of total 24 bit data signals, the 16,194,277 million-color display can be achieved on the screen.

## 9. Optical characteristics

Table 9-1

 $Ta{=}25^{\circ}\!\!\!\mathrm{C}\,$  , Vcc=+3.3V , VB+=13.5V , BL\_PWM=100% , Initial Value

Parame	eter	Symbol	Condition	Min	Typ	Max	Unit	Remarks
Viewing A	Angle	$\theta 21,\! \theta 22$	CR≧10	70	85	-	degree	[Note 9-1,2]
Rang	e	$\theta11,\theta12$	O <b>n</b> ≦10	70	85	-	degree	
Contrast		CRmax	θ=0°	1100	2000	ı		[Note 9-2]
Response	Rise	$ au \mathbf{r}$		ı	15	35	ms	[Note 9-3]
time	Fall	τd		ı	5	15	ms	[Note 9 5]
		x (white)		0.255	0.290	0.330		[Note 9-6]
		y (white)		0.280	0.320	0.360		[Note 5 6]
		x (red)		0.592	0.622	0.652		±0.03
Color	ſ	y (red)		0.318	0.348	0.378		NTSC ratio is
Chromat	icity	x (green)		0.290	0.320	0.350		Typ(64)%.
	•	y (green)		0.585	0.615	0.645		
		x (blue)		0.120	0.150	0.180		
		y (blue)		0.060	0.090	0.120		
Lumina	nce	Y		375	500	-	cd/ <b>m</b> ²	
Off-Axis	Half	$\theta 21,\! \theta 22$	-	35	45	-	degree	[Note 9-1]
Brightn	ess	$\theta11,\theta12$	-	20	30	-	degree	
Uniformity		u	-	-	85	-	%	[Note 9-5]
LED	LED +25℃		continuation	10,000	-	-	hour	[Note9-4]
lifetime								

<sup>\*</sup>Above specification warrants only initial condition.

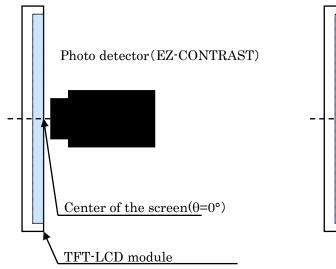


Fig. 6 The way of measuring
Viewing angle range/ Response time

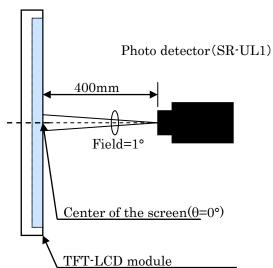
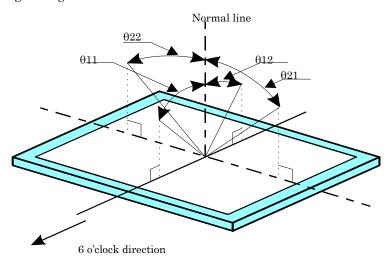


Fig. 7 The way of measuring Luminance/ Chromaticity/ Contrast

<sup>\*</sup>Measured after 30 minutes operation. The optical characteristic is measured by using the method of fig.6 and fig.7 under the condition of the darkroom or equivalent to it.

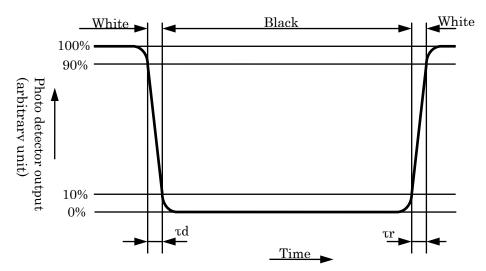
[Note9-1] Viewing angle range is defined as follows.



[Note9-2] Contrast ratio of transmission is defined as follows:

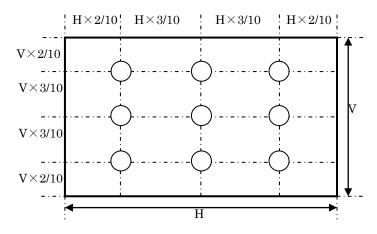
Contrast ratio (CR)= Photo detector output with LCD being "white"
Photo detector output with LCD being "black"

[Note9-3] Response time is obtained by measuring the transition time of photo detector output, when input signals are applied so as to make the area "black" to and from "white".

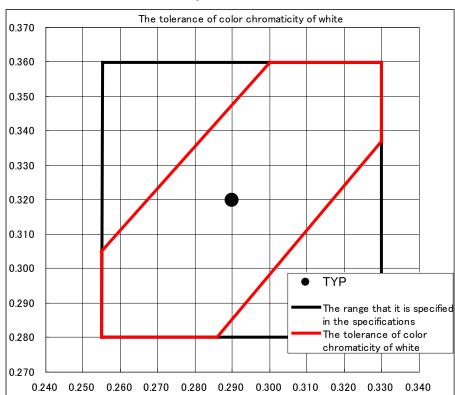


[Note9-4] LED life time is defined as the time when the brightness of the panel is not become less than 50% of the original value in the continuous operation under the condition of LED current If= 60 mArms and PWM dimming 100%~5% (Ta=25°C).

[Note9-5] u=Ymin/Ymax:(9points luminance)



[Note 9-6] The tolerance of color chromaticity of white is shown as follows



## 10. Display quality

The display quality of the module shall be in compliance with the Incoming Inspection Standards. Please reference document number LDIE-101KFO01.

## 11. Mechanical characteristics

## 11-1 External appearance

No extreme defect exists. (See Fig. 1)

### 11-2 LCD Panel toughness

The LCD panel shall not be broken, when 19N is pressed on the center of the panel by a smooth sphere having 15 mm diameter.

Caution: In spite of very soft toughness, continuous pressure on the active area may cause functional damage.

## 12. Handling instructions

## 12-1 Mounting of module

- The TFT-LCD module is designed to be mounted on hardware using the mounting features that are located on the back side of the module.
  - Side mount features may also be used with back side mounting.
- When mounting the module, M3 type screw (fastening torque is TYP0.6N·m(design target)) is recommended for back side, M2.5 type screw (fastening torque is TYP0.4N·m(design target)) is recommended for side mount. Take care to mount the module on the same plane. Take caution not to warp or twist the module during mounting.
- Do not apply pressure on the front surface of the glass or metal frame of the LCD module as this
  could cause the image to be distorted.
- Always turn the power off to the module when connecting or disconnecting the flex cable to the main connector.
- Please ensure that the LCD metal case is grounded in the system design.

## 12-2 Precautions in mounting

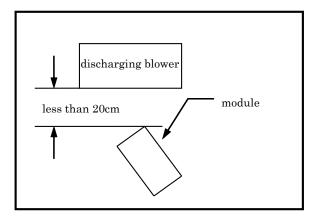
- The polarizer is made of soft material and is susceptible to damage. Please handle the module carefully.
- A protective sheet is applied on the surface of the module to protect it against scratches and dirt.
- It is recommended to remove the protective sheet just before assembly or use. ESD precaution should be used during the removal of the sheet.
- Precautions in removing the protection sheet:
  - A) Working environment

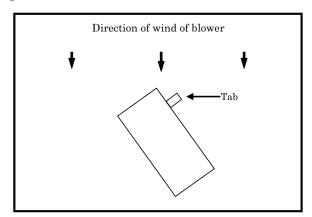
When the protection sheet is removed, static electricity may cause dust to stick to the polarizer surface. To avoid this, the following working environment is recommended:

- Floor: Conductive treatment of  $1M\Omega$  or more on the tile (conductive mat or conductive paint on the tile)
- Clean room free from dust and with an adhesive mat in the doorway
- Recommended humidity:50%~70% Recommended temperature:15C~27C
- Workers shall wear conductive shoes, conductive work clothes, conductive gloves and a ground strap.

## B) Working procedures

- Use an ionized air supply when removing the protective sheet. Direct the air slightly downward. Keep the distance between the LCD module and the ionized air supply within 20 cm.
- Remove the protective sheet, pulling the tab slowly towards you.
- Immediately after the protective sheet is removed, pass the module to the next work process to prevent the module to get dust.





- Method of removing dust from polarizer:
  - Blow off any dust with an N2 blower for which static electricity preventive measure has been taken.
  - Since polarizer is vulnerable to scratches, wiping should be avoided.
  - But when the panel has stain or grease, to use adhesive tape is recommended to remove them softly from the panel.
- When metal part of the TFT-LCD module (shielding lid and rear case) is dirty, wipe it with a soft dry cloth. For stubborn dirt, apply a slight condensation on the metal and then gently wipe it off.
- Wipe off any water drops or finger grease immediately. Prolonged contact with water may cause discoloration or spots.
- The TFT-LCD module contains glass which can break or crack easily if dropped or bumped on a hard surface. Please handle with care.
- Since CMOS devices are used in this product, use ESD precaution when handling such as connecting a ground strap to your body.

## 12-3 Caution of product design

Please follow the notes below when designing this LCD module into your system.

- The LCD module shall be protected against water or saltwater with a waterproof cover.
- Please apply necessary design methods to not allow the LCD to interfere with surrounding appliances.

### 12-4 Others

- Liquid crystal is sensitive to ultraviolet rays. Do not expose the module to direct sunlight for a long time.
- Storage of the module under temperatures lower than the specified range may solidify the liquid crystal in the module, resulting in damage to the panel. Storage of the module under temperatures exceeding the specified range may cause an irreversible change of the liquid crystal to the isotropic phase.
- When the LCD is broken, do not ingest the liquid crystal. If any liquid crystal adheres to your skin or clothes, wash it off immediately with soap and water.
- Immediately remove any water droplets or dirt on the polarizer. Failure to do so may cause degradation.
- Observe all other precautionary requirements in handling general electronic components.
- The LCD has been calibrated prior to shipment, do not change any of the adjustable values within the LCD module.

## 13. Packing form

13-1 The packing form figure: See Fig.4

13-2

a)Piling number of cartons : MAX 8

b)Conditions for storage

Environment

①Temperature:  $0\sim40^{\circ}$ C

②Humidity : 60%RH or less (at 40°C)

No dew condensation at low temperature and high humidity.

3Atmosphere: Harmful gas, such as acid or alkali which bites electronic components and/or

wires, must not be detected.

④Period : about 3 months

⑤Opening of the package: In order to prevent the LCD module from breakdown by electrostatic

charges, please control the room humidity over 50% RH and open the package taking sufficient countermeasures against electrostatic

charges, such as earth, etc.

#### 14.Others

14-1) Indication of lot number

①Attached location of the label

: See Fig.1 (Outline Dimensions).

②Indicated contents of the label



Contents of model No. the 1st  $\sim$ 11th figure · · model No.

the 12th · · management division

Contents of lot No. the 1st figure  $\cdots$  production year (ex. 2011  $\rightarrow$  1)

the 2nd figure · · production month 1,2,3,· · · · · ,9,X,Y,Z

the 3rd $\sim$ 8th figure  $\cdots$  serial No. 000001 $\sim$  the 9th figure  $\cdots$  revision marks space,A,B,C $\cdots$ 

14-2)Pb-free Environmental burden status

This TFT-LCD module is chromium hexavalent-free and Pb-free

## 15. Reliability Test Conditions and Sequence for TFT-LCD Module

Table 15-1 Reliability Test and Sequence (Based on CETP: 00.00-e-412 and EMC-CS-2009)
Remark) Temperature condition is based on operating temperature conditions on Table 9-1.

If DV samples are produced by production tooling, production material and production operators at production rate and location, the DV testing is equivalent to PV testing.

r	operato	is at production rate and location, the			l costiliag.	
Item	Procedure	Procedure Title	Reqm't Value	Evaluati	Sample	Sample
No.	No.			on Phase	Qty	Type
Leg 1	Group A	MECHANICAL/ ENVIRONMENTAL	T	I	I	I
1.01	6.2.1	Performance/Functional Evaluation	Refer to Table 15-2	DV/PV	1	ES/CS
1.02	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	3	ES/CS
1.03	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.04	6.4.5.1	LOW TEMPERATURE EXPOSURE	NOT REQUIRED FOR T			
1.05	6.2.2	Functional Check	NOT REQUIRED FOR T			
1.06	6.2.5	Visual Check(External)	NOT REQUIRED FOR T			ı
1.07	6.4.5.2	LOW TEMPERATURE OPERATION	-30℃ 24hrs	DV/PV	12	ES/CS
1.08	6.2.2	Functional Check	NOT REQUIRED FOR T	HIS DISPLA	Y	ı
1.09	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.10	6.4.5.3	HIGH TEMPERATURE EXPOSURE	NOT REQUIRED FOR T	HIS DISPLA	Y	
1.11	6.2.2	Functional Check	NOT REQUIRED FOR T	HIS DISPLA	Y	
1.12	6.2.5	Visual Check(External)	NOT REQUIRED FOR T	HIS DISPLA	Y	ı
1.13	6.4.5.4	HIGH TEMPERATURE OPERATION	75℃ 24hrs	DV/PV	12	ES/CS
1.14	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	3	ES/CS
1.15	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.16	6.4.5.5	POWERED THERMAL CYCLE	-30 to 75	DV/PV	12	ES/CS
			240hrs(30cycle)			
1.17	6.2.2	Functional Check	NOT REQUIRED FOR T	HIS DISPLA	Y	
1.18	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.19	6.4.5.6	THERMAL SHOCK RESISTANCE	-40°C to 95°C	DV/PV	12	ES/CS
			12hrs(6cycle)			
1.20	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	3	ES/CS
1.21	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.22	6.4.6.1	POWERED VIBRATION (Vibration-Sine)	Class 1 Mild 18h	DV/PV	12	ES/CS
1.23	6.2.2	Functional Check	NOT REQUIRED FOR T	HIS DISPLA	Y	1
1.24	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.25	6.4.6.2	AUDIBLE NOISE UNDER VIBRATION	1hr	DV/PV	12	ES/CS
1.26	6.2.2	Functional Check	NOT REQUIRED FOR T	HIS DISPLA	Y	
1.27	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.28	6.4.6.3.1	PACKAGE DROP	100cm to floor once	PV	14direc	ES/CS
			each surface & corner		tions	
1.29	6.4.6.3.4	LOW MECHANICAL SHOCK	50g/6cycles/3axis/	DV/PV	12	ES/CS
			each direction			
1.30	6.2.2	Functional Check	NOT REQUIRED FOR T	HIS DISPLA	Y	1
1.31	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.32	6.4.5.8	HUMIDITY-TEMPERATURE CYCLING	60℃90%RH	DV/PV	12	ES/CS
			45℃95%RH -10℃			
			120hrs(5cycles)			
1.33	6.4.5.9	WATER / FLUID INGRESS	NOT REQUIRED FOR T	HIS DISPLA	.Y	
1.34	6.4.5.10	DUST INTRUSION	NOT REQUIRED FOR T	HIS DISPLA	Y	
1.35	6.4.7.1	SALT MIST ATMOSPHERE	NOT REQUIRED FOR T	HIS DISPLA	Y	
1.36	6.4.7.2	CHEMICAL RESISTANCE	NOT REQUIRED FOR T	HIS DISPLA	Y	
1.37	6.4.6.4	CONNECTER LEAD / LOCK STRENGTH	NOT REQUIRED FOR T	HIS DISPLA	Y	
1.38	6.2.1	Performance/Functional Evaluation	Refer to Table 15-2	DV/PV	1	ES/CS
1.39	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	3	ES/CS
1.40	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
1.41	6.2.6	Internal Inspection	Refer to Table 15-2	DV/PV	12	ES/CS
		-				

Item	Procedure	Procedure Title	Reqm't Value	Evaluati	Sample	Sample
No.	No.			on Phase	Qty	Type
	Group C	MECHANICAL/ ENVIRONMENTAL	NOT REQUIRED FOR THIS DISPLAY			

Item	Procedure	Procedure Title	Reqm't Value	Evaluati	Sample	Sample
No.	No.			on Phase	Qty	Type
Leg 2	Group D	MECHANICAL/ ENVIRONMENTAL				
2.01	6.2.1	Performance/Functional Evaluation	Refer to Table 15-2	DV/PV	1	ES/CS
2.02	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	8	ES/CS
2.03	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	8	ES/CS
2.04		Solder check	Level 3	DV/PV	2	ES/CS
2.05	6.4.5.7	THERMAL SHOCK ENDURANCE	-40°C to +95°C	DV/PV	6	ES/CS
			Ohrs to 250hrs			
2.06	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	6	ES/CS
2.07	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	6	ES/CS
2.08	6.4.5.7	THERMAL SHOCK ENDURANCE	-40°C to +95°C	DV/PV	6	ES/CS
			250hrs to 500hrs			
2.09	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	6	ES/CS
2.10	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	6	ES/CS
2.11	6.4.5.7	THERMAL SHOCK ENDURANCE	-40°C to +95°C	DV/PV	6	ES/CS
			500hrs to 750hrs			
2.12	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	6	ES/CS
2.13	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	6	ES/CS
2.14	6.4.5.7	THERMAL SHOCK ENDURANCE	-40°C to +95°C	DV/PV	6	ES/CS
			750hrs to 1000hrs			
2.15	6.2.1	Performance/Functional Evaluation	Refer to Table 15-2	DV/PV	1	ES/CS
2.16	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	6	ES/CS
2.17	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	6	ES/CS
2.18	6.2.6	Internal Inspection	Refer to Table 15-2	DV/PV	3	ES/CS
2.19		Solder check	Level 3	DV/PV	3	ES/CS
2.20	6.4.5.7	THERMAL SHOCK ENDURANCE	-40°C to +95°C	NOTE	3	ES
			1000hrs to 1250hrs	[15-1]		
2.21	6.2.2	Functional Check	Refer to Table 15-2		3	ES
2.22	6.4.5.7	THERMAL SHOCK ENDURANCE	-40°C to +95°C		3	ES
			1250hrs to 1500hrs			
2.23	6.2.2	Functional Check	Refer to Table 15-2		3	ES
2.24	6.4.5.7	THERMAL SHOCK ENDURANCE	-40°C to +95°C		3	ES
			1500hrs to 1750hrs			
2.25	6.2.2	Functional Check	Refer to Table 15-2		3	ES
2.26	6.4.5.7	THERMAL SHOCK ENDURANCE	-40°C to +95°C		3	ES
			1750hrs to 2000hrs			
2.27	6.2.2	Functional Check	Refer to Table 15-2		3	ES
2.28		Solder check	Level 3		3	ES

Note 15-1 Above information is only for reference and not requirement for DV or PV tests as an acceptance criteria.

Item	Procedure	Procedure Title	Reqm't Value	Evaluati	Sample	Sample
No.	No.			on Phase	Qty	Type
Leg 3	Group E	MECHANICAL/ ENVIRONMENTAL				
3.01	6.2.1	Performance/Functional Evaluation	Refer to Table 15-2	DV/PV	1	ES/CS
3.02	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	6	ES/CS
3.03	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	6	ES/CS
3.04	6.4.8.1	HIGH TEMPERATURE ENDURANCE	+75℃ Operation	DV/PV	6	ES/CS
			1000hrs			
3.05	6.2.1	Performance/Functional Evaluation	Refer to Table 15-2	DV/PV	1	ES/CS
3.06	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	6	ES/CS
3.07	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	6	ES/CS
3.08	6.2.6	Internal Inspection	Refer to Table 15-2	DV/PV	6	ES/CS

Item	Procedure	Procedure Title	Reqm't Value	Evaluati	Sample	Sample
No.	No.			on Phase	Qty	Type
Leg 4	Group F	MECHANICAL/ ENVIRONMENTAL	MECHANICAL/ ENVIRONMENTAL			
4.01	6.2.1	Performance/Functional Evaluation	Refer to Table 15-2	DV/PV	2	ES/CS
4.02	6.2.2	Functional Check	Refer to Table 15-2	DV/PV	12	ES/CS
4.03	6.2.5	Visual Check(External)	Refer to Table 15-2	DV/PV	12	ES/CS
4.04	6.4.8.4	HUMIDITY TEST	+60°C90%RH 1000hrs	DV/PV	6	ES/CS
			+65°C90%RH 1000hrs	NOTE	6	
4.05	6.2.1	Performance/Functional Evaluation	Refer to Table 15-2	[15-2]	2	ES/CS
4.06	6.2.2	Functional Check	Refer to Table 15-2		12	ES/CS
4.07	6.2.5	Visual Check(External)	Refer to Table 15-2		12	ES/CS
4.08	6.2.6	Internal Inspection	Refer to Table 15-2		12	ES/CS

Note 15-2 Above information is only for reference and not requirement for DV or PV tests as an acceptance criteria.

Item No.	Procedure No.	Procedure Title	Reqm't Value	Evaluati on Phase	Sample Qty	Sample Type
No.	INO.			Note	Qty	Туре
				[15-3]		
Leg 5	Group G	ELECTROMAGNETIC COMPATIBILITY (F	EMC)	•	•	
6.01	RE 310	RADIATED RF	Level 2	NOTE [15-4]	2	ES/CS
6.02	CE 420	CONDUCTED RF	NOT REQUIRED FOR T	HIS DISPLA	Y	
6.03	RI 112	RF IMMUNITY	NOT REQUIRED FOR T			
6.04	RI 114	RF IMMUNITY	Class C	NOTE	2	ES/CS
				[15-4]		
6.05	RI 130	INDUCATE	NOT REQUIRED FOR T	HIS DISPLA	Υ	
6.06	RI 150	CHARGING SYSTEM	NOT REQUIRED FOR T	HIS DISPLA	Y	
6.07	CI 260	VOLTAGE DROPOUT	NOT REQUIRED FOR T	HIS DISPLA	Y	
6.08	CI 280	ESD Handling Test	Casing	NOTE		ES/CS
			150pF 2kΩ 8kV	[15-5]	3	
			Terminal			
			100pF 1.5kΩ 2kV		3	
			200pF 0Ω 200V		3	
		ESD POWERED TEST	Surface	NOTE	3	ES/CS
			$300 \mathrm{pF}$ $2\mathrm{k}\Omega$ $\pm 15\mathrm{kV}$	[15-5]		
			150pF 1.5kΩ (±25Kv)			

Note 15-3 Tests to be performed with Ford Approved Test Box

Note 15-4 Above information is only for reference and not requirement for DV or PV tests as an acceptance criteria.

Note 15-5 ESD test should be done in SHARP internal facility.

Table 15-2 Performance Parameters and Functional Characteristics

Item	Parameter	Performance/Functional	Functional Check	Visual Check	Internal
Tucin	Tarameter	Evaluation	6.2.2	6.2.5	Inspection
		6.2.1	0.2.2	0.2.5	6.2.6
1	Viewing	As mentioned in the	As mentioned in the	_	-
1	Angle Range	specifications	specifications		
2	Contrast	It is within -60% when it is	It is within -30% when it	_	_
2	Ratio			_	
	Katio	compared with Functional	is compared with initial		
	D	Check value	value	_	
3	Response	tr + tf = 450  ms	As mentioned in the	_	_
4	Time Color	when low temp  It is within ±0.04 when it is	specifications It is within $\pm 0.04$ when	_	_
4				_	
	Chromaticity	compared with Functional	it is compared with		
_	т .	Check value	initial value	_	_
5	Luminance	It is within 50% when it is	It is within -30% when it	_	_
		compared with Functional	is compared with initial		
	0.00 4 1 77 10	Check value	value		
6	Off-Axis Half	It is within 10° when it is	As mentioned in the	_	_
	Brightness	compared with Functional	specifications		
	77.16	Check value	T. 1		
7	Uniformity	It is within -30% when it is	It is within -30% when it	_	_
		compared with initial value.	is compared with initial		
		*Room temperature only	value		
8	Luminance	[Note 15-8]	_	_	_
	Rising-up	*Ta=-20℃ only			
9	Contrast	Minimum 3:1	_	_	_
	Ratio	*Ta=85℃ (Dimming 20%)			
	at 85℃	only			
10	Reflectance	It is within +50% when it is	_	_	_
		compared with initial value.			
		*Room temperature only			
11	VB+ Current	As mentioned in the	As mentioned in the	_	_
	Dissipation	specifications	specifications		
12	VCC Current	As mentioned in the	As mentioned in the	_	_
	Dissipation	specifications	specifications		
13	Horizontally	_	<u>~</u>	Vhen HRV is High,	_
	Inverted			Horizontally inverted	
	Video			video	
14	Vertically	_	<u>-</u>	Vhen VRV is High,	_
	Inverted			vertically inverted	
	Video			video	
15	Thermistor		_	When LCD doesn't	
	Output			work, the resistance	
	-			value of the	
				thermistor is $6.8 \mathrm{k}\Omega$ $\sim$	
				$22\mathrm{k}\Omega$ .	
16	PWM	_	_	When PWM is moved,	_
	Dimming			the brightness	
				changes.	
17	Bright dot	_	_	Refer to IIS	_
18	Black dot	_	_	Refer to IIS	_
19	Image	_	_	No Image Distortion	_
10	Distortion			1.0 Image Distributi	
20	Corrosion	_	_	_	There is no
20	COLLOSION				corrosion which
					has an influence
					with the
					performance.
	<u> </u>	<u>L</u>	L	l	performance.

21	Broken/Dam aged Component	_	_	There is no broken/damaged component corrosion which has an influence with the performance.	There is no broken/damaged component corrosion which has an influence with the performance.
22	Solder Cracks	_	-	_	There is no Solder Cracks of the level 4.
23	LCD Error BL Error	_	_	_	Error pin functionality to be tested and verified

Note 15-6 Performance/Functional Evaluation(6.2.1)

These LCD Module performance parameters are measured and recorded as specified in the LCD Module engineering specification at the 5 temperature-voltage points listed bellow

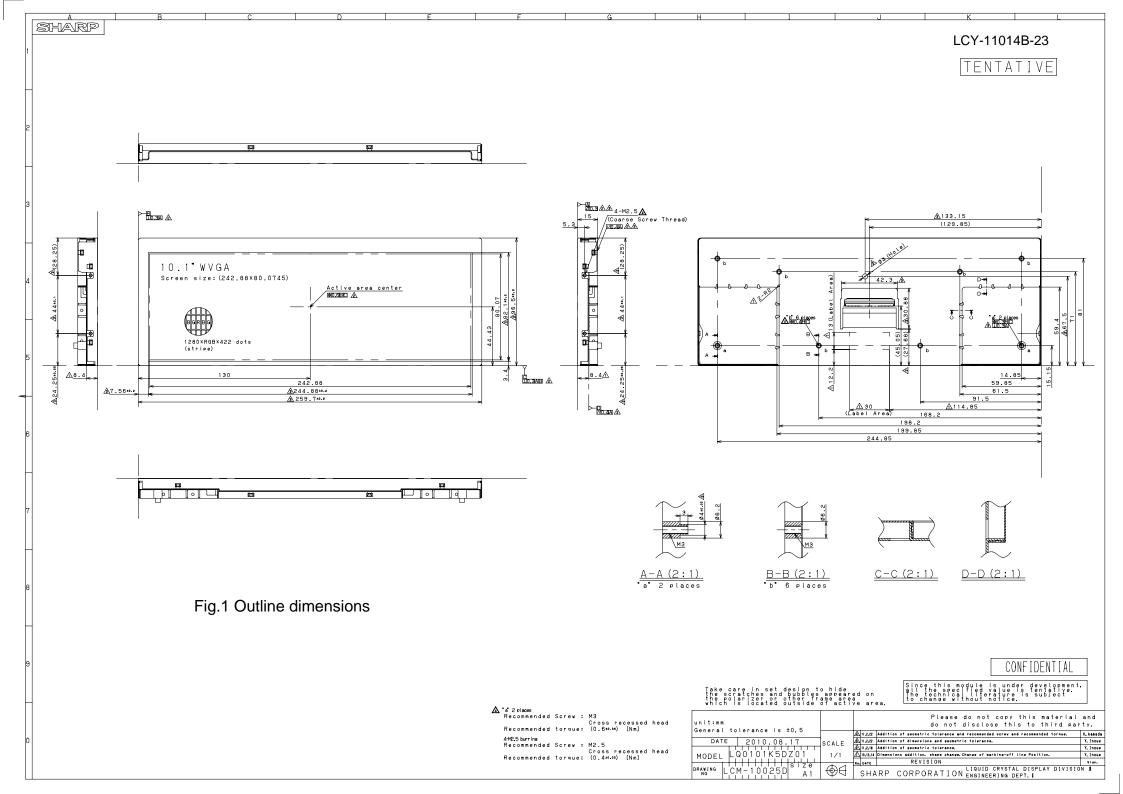
1) Ta=-30℃	Vb+=7V	Vcc=3.0V
2) Ta=-30°C	Vb+=16V	Vcc=3.6V
3) Ta= $20 \pm 15$ °C	Vb+=13.5V	Vcc=3.3V
4) Ta=75°C	Vb+=7V	Vcc=3.0V
5) Ta=75℃	Vb+=16V	Vcc=3.6V

Note 15-7 Functional Check(6.2.2)

LCD Module is operated at Ta=20  $\pm$  15 °C ,Vb+=13.5V,Vcc=3.3V and its function and performance characteristics are evaluated as specified in the LCD Module specification.

Note 15-8 50% of room temperature luminance intensity shall be achieved at an instance of system start-up at -20 $^{\circ}$ C.

90% of room temperature luminance intensity shall be achieved within 30 seconds of system start-up at  $^{\circ}20^{\circ}\!\text{C}.$ 



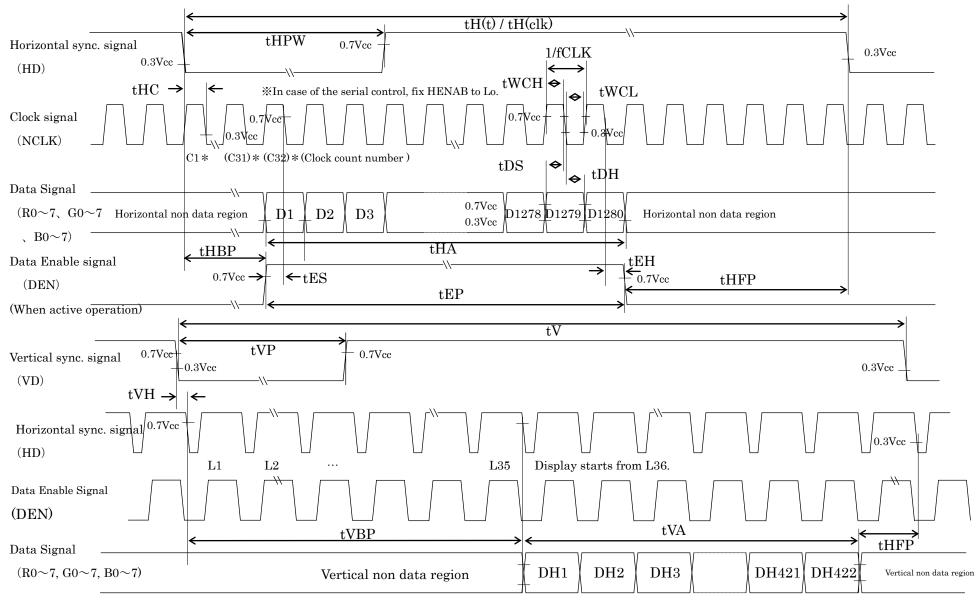


Fig. 2: Input signal timing chart

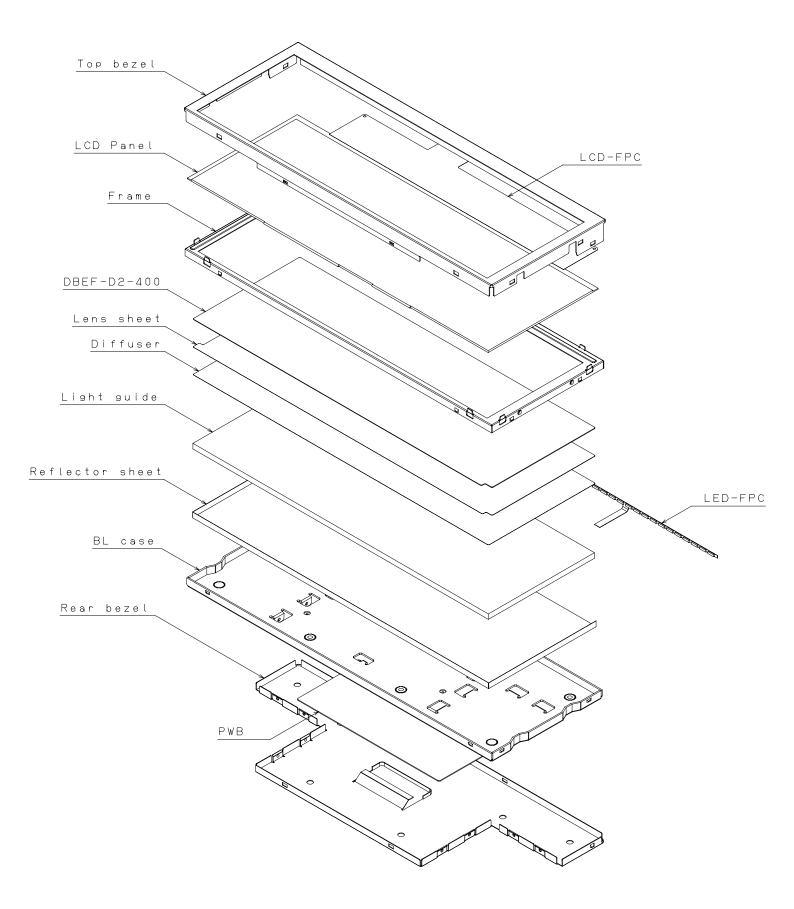


Fig.3 Main composition parts

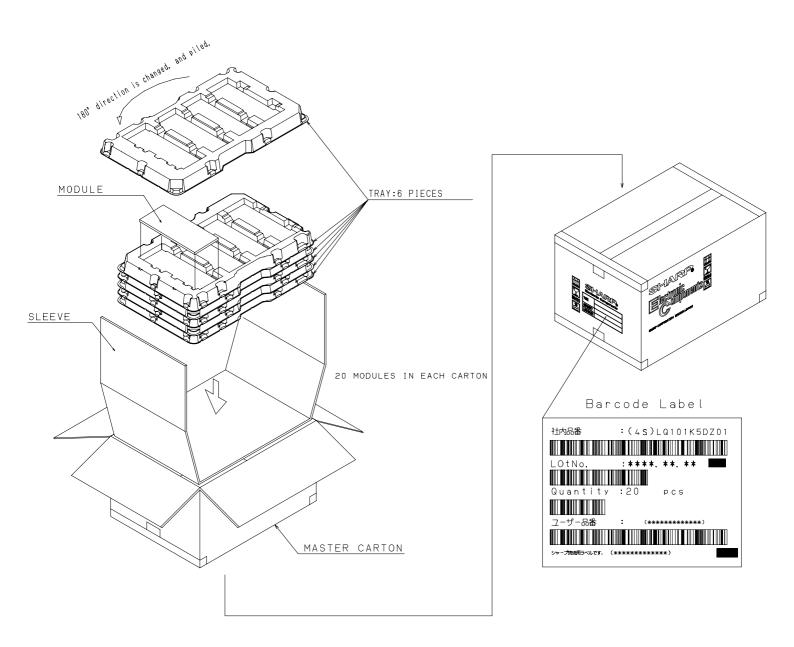


Fig.4 Packing Form

## LQ101K5DZ01 Appendix A

LCD_Error Pin Information		
Functional Description	To check if source driver/gate driver start pulse signal returns in a specific time or not	
Error judgment criteria (source driver)	<ul> <li>After start pulse signal (STHL/STHR), the ASIC checks if the start pulse signal returns back within a specific period.</li> <li>If the ASIC does not receive the start pulse return within the given period, the ASIC will activate open drain FET.</li> </ul>	
Error judgment criteria (gate driver)	•After start pulse signal (GSPOI/GSPIO), the ASIC checks if the start pulse signal returns back within a specific period. •If the ASIC does not receive the start pulse return within the given period, the ASIC will activate open drain FET.	
Error reset condition	LCD_Error pin will go back to a non-error state if:  •The ASIC receives both source/gate driver start pulse signals in the required time periods	
How to attempt to reset	<ul> <li>Follow module power down/up timing sequence as described in the specification OR</li> <li>Only toggle PON low per the timing requirements (while keeping other signals active), then assert PON high again.</li> </ul>	
When to start to monitor	•10 VSYNCs after Power Up sequence is complete	
Interface Drawing	LCD_Error ASIC ASIC	

BL_Error Pin Information		
Functional Description	To check output over voltage, open-LED, short-LED and over temperature.	
Error judgment criteria	<ul> <li>If the output voltage exceed the Vovp voltage set. (over voltage,open-LED)</li> <li>If the returned voltage exceed the voltage set. (short-LED)</li> <li>If the temperature of LED driver over +165°C.</li> </ul>	
Error reset condition	BL_Error pin will go back to a non-error state if:  the temperature of LED driver falls below +165°C.  over voltage, open-LED and short-LED condition go back normally and cycling power or toggling the PON	
How to attempt to reset	<ul> <li>Follow module power down/up timing sequence as described in the specification OR</li> <li>Only toggle PON low per the timing requirements (while keeping other signals active), then assert PON high again.</li> </ul>	
When to start to monitor	• 10 VSYNCs after Power Up sequence is complete	
Interface Drawing	BL_Error 1000hm 1 µF LED driver	